

**LIST OF CURRENT CLAIMS:**

Claims 1-6 (Previously Canceled)

7. (Previously Amended) A process for sawing a substrate strip having a plurality of substrate areas by a saw machine, and the process comprising the steps of:  
providing a plurality of alignment marks around each individual substrate area on the substrate strip;

providing a plurality of cutting marks around each individual substrate area on the substrate strip;

positioning the saw machine with respect to each individual substrate area in accordance with the alignment marks therearound;

cutting each individual substrate area on the substrate strip by the saw machine respectively according to cutting tracks defined by the cutting marks;

wherein the substrate strip has a longitudinal axis and a lateral axis and the substrate areas are disposed along the longitudinal axis, the saw machine is positioned with respect to a first substrate area according to the alignment marks along the longitudinal axial from one side thereof and cuts the substrate strip according to cutting tracks defined by the cutting marks parallel to the lateral axis;


repositioning the saw machine with respect to an adjacent one of the substrate areas; and

cutting the substrate strip, whereby cutting error that results from each substrate area will not accumulate to the subsequent substrate areas in the substrate strip.

Claim 8 (Previously Canceled)

9. (Currently Amended) The process as claimed in ~~Claim~~ claim 7, further comprising the step of cutting the substrate strip according to cutting tracks defined by the cutting marks parallel to the longitudinal axis.--

10. (Currently Amended) The process as claimed in ~~Claim~~ claim 7, wherein each individual substrate area is provided with at least three alignment marks.

 11. (Currently Amended) The process as claimed in ~~Claim~~ claim 7, further comprising an encapsulated area on each ~~each~~ individual substrate area, and the encapsulated area is provided with at least three alignment marks therearound.

12. (Currently Amended) The process as claimed in ~~Claim~~ claim 7, wherein two substrate strips are juxtaposed for cutting simultaneously.

13. (Currently Canceled)

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